

## C0603C910G2GACTU

Aliases (C0603C910G2GAC7867) SMD Comm C0G, Ceramic, 91 pF, 2%, 200 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603, 0.5 mm



	<b>\</b> \///	remination
		Marking
	s	AEC-Q200
		Typical Component Weigh
Click here for the 3D model.		Shelf Life
		MSL
Dimensions		Specifications
Chip Size	0603	Capacitance
L	1.6mm +/-0.15mm	Measurement Condition
W	0.8mm +/-0.15mm	Tolerance

0.8mm +/-0.07mm

0.35mm +/-0.15mm

0.5mm MIN

Packaging Specifications		
Packaging	T&R, 180mm, Paper Tape	
Packaging Quantity	4000	

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В

General Information				
Series	SMD Comm COG			
Style	SMD Chip			
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I			
Features	Ultra-Stable, Low Loss, Class I			
RoHS	Yes			
Termination	Tin			
Marking	No			
AEC-Q200	No			
Typical Component Weight	3.7 mg			
Shelf Life	78 Weeks			
MSL	1			

Specifications	
Specifications	
Capacitance	91 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	2%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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